U.S. PTO 11/804237 05/17/2007

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FORM PTO-1595

RECORDATION FORM COVER 103412336
PATENTS ONLY

<u>TI-62573</u> PAII	ENTS ONLY
To the Assistant Commissioner for Patents. Please record the attached	original documents or copy thereof.
Name of conveying party(ies):	2. Name and Address of receiving party(ies):
PREMA PALANIAPPAN, MASOOD MURTUZA,	Name: TEXAS INSTRUMENTS INCORPORATED
and SATYENDRA SINGH CHAUHAN	Address: P.O. Box 655474, MS 3999
	D. II.
	City: Dallas
	State: TX Zip: 75265
	Additional name(s) & address(es) attached?Yes _X_ No
3. Nature of Conveyance:	
X Assignment Merger	
Security Agreement Change of Name	
Other	
Execution Date: MAY 16, 2007	
Application number(s) or patent number(s).	
X_This document is being filed together with a new application.	
Execution date of the application: MAY 17, 2007 Title: MULTI LAYER LOW COST CAVITY SUBSTRAT	TE FABRICATION FOR POP PACKAGES
Docket No: TI-62573	
A. Patent Application No.(s)	B. Patent No.(s)
Additional numbers attached 9 Vac V No.	
Additional numbers attached?YesXNo	Additional numbers attached?YesXNo
Name and address of party to whom correspondence concerning document should be mailed:	Additional numbers attached?YesXNo 6. Number of applications and patents involved:(1)
Name and address of party to whom correspondence concerning	
Name and address of party to whom correspondence concerning document should be mailed: Name: Yingsheng Tung, Reg. No. 52,305 Texas Instruments Incorporated	
5. Name and address of party to whom correspondence concerning document should be mailed: Name: Yingsheng Tung, Reg. No. 52,305 Texas Instruments Incorporated Address: P.O. Box 655474, MS 3999	
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05/31/2007 01 FC:8021

PATENT

REEL: 019388 FRAME: 0038

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 7839 Churchill Way, M/S 3999, Dallas, Texas 75251, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, title and interest.

I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE OF INVENTION	MULTI LAYER LOW COST CAVITY SUBSTRATE FABRICATION FOR POP PACKAGES
SIGNATURE OF INVENTOR AND NAME	PREMA PALANIAPPAN
DATE	MAY 16, 2007
RESIDENCE (City, State)	RICHARDSON, TX
DATE APPLICATION EXECUTED	MAY 16, 2007

PATENT

REEL: 019388 FRAME: 0039

TITLE OF INVENTION	MULTI LAYER LOW COST CAVITY SUBSTRATE FABRICATION FOR POP PACKAGES
SIGNATURE OF INVENTOR AND NAME	Masood MURTUZA
DATE	MAY 16, 2007
RESIDENCE (City, State)	SUGAR LAND, TX
DATE APPLICATION EXECUTED	MAY 16, 2007

TITLE OF INVENTION	MULTI LAYER LOW COST CAVITY SUBSTRATE FABRICATION FOR POP PACKAGES
SIGNATURE OF INVENTOR AND NAME	Satyendra Singh Chauhan SATYENDRA SINGH CHAUHAN
DATE	MAY 16, 2007
RESIDENCE (City, State)	SUGAR LAND, TX
DATE APPLICATION EXECUTED	MAY 16, 2007

After recordation, please return Assignment to:

RECORDED: 05/17/2007

Yingsheng Tung
Texas Instruments Incorporated
P.O. Box 655474, M/S 3999
Dallas, TX 75265

PATENT

REEL: 019388 FRAME: 0040